



Dynasolve 180

Cured Polymer Cleaning Solvent



Dynasolve 180 is a cleaning solvent that is used for removing cured urethane, crystallized isocyanate, and cured epoxy. It is used in a broad variety of electronic and industrial cleaning applications.

CLEANING APPLICATIONS:

Industrial urethane and epoxy removal and cleaning
Electronic urethane and epoxy removal and cleaning
Crystallized isocyanate cleaning

ADVANTAGES:

More efficient than acetone, MEK and other solvents
High resin loading capacity allows for reuse and reduced cost of ownership
High flash point

SPECIFICATIONS:

Specific gravity:	1.03
Boiling point:	395°F (202°C)
Flash point:	195°F (91°C)

MATERIALS REMOVED:

Cured urethane
Crystallized isocyanate
Cured epoxies

PRODUCT USAGE GUIDELINES

(SEE SDS FOR EH&S INFORMATION)

1. Immerse part in Dynasolve 180 at room temperature
 - Note: Cured epoxy requires heating to >200°F (<93°C)
2. Observe carefully. If cured material appears unaffected after 1 hour, heat solvent to 130°-150°F (55°-66°C).
3. If material appears unaffected after 2 hours, call Versum Materials Dynaloy for technical support.

MATERIAL COMPATIBILITY:

Recommended materials including:

All metals
Teflon®
Polyethylene, polypropylene and mylar

Avoid materials including:

Viton®
PVC
ABS



VERSUM MATERIALS, LLC

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